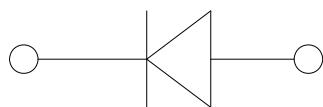
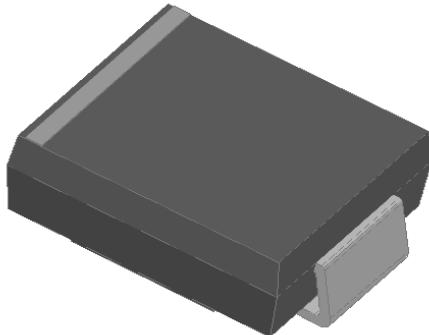


Surface Mount Schottky Rectifier



Features

- Guardring for overvoltage protection
- Low power losses
- Extremely fast switching
- High forward surge capability
- High frequency operation
- Solder dip 260°C max. 10 s, per JESD 22-B106

Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

Mechanical Data

- **Package:** DO-214AB (SMC)
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Color band denotes the cathode end

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS52	SS54	SS56	SS510	SS515	SS520
Device marking code			SS52	SS54	SS56	SS510	SS515	SS520
Repetitive Peak Reverse Voltage	V _{RRM}	V	20	40	60	100	150	200
Average Rectified Output Current @60Hz sine wave, Resistance load, Ta (FIG.1)	I _O	A			5.0			
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, Ta=25°C	I _{FSM}	A			100			
Storage Temperature	T _{STG}	°C			-55 ~ +150			
Junction Temperature	T _j	°C	-55~+125		-55 ~ +150			

■ Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	SS52	SS54	SS56	SS510	SS515	SS520
Maximum instantaneous forward voltage drop per diode	V _F	V	I _{FM} =5.0A	0.55	0.60	0.70	0.85	0.90	
Maximum DC reverse current at rated DC blocking voltage per diode	I _R	mA	T _a =25°C		0.2			0.1	
			T _a =100°C		20			5	
Typical junction capacitance	C _j	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C.	280	220	180	100		

Note1:Pulse test:300uS pulse width,1% duty cycle

Note2:Pulse test:pulse width 40mS

SS52 THRU SS520

■ Thermal Characteristics ($T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	SS52	SS53	SS54	SS55	SS56	SS58	SS510	SS515	SS520
Thermal Resistance	Junction to ambient	$R_{\theta JA}$	$^\circ\text{C/W}$			47 ⁽¹⁾						
	Junction to lead	$R_{\theta JL}$				13 ⁽¹⁾						

Note(1)

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16 mm) copper pad areas

■ Ordering Information (Example)

PREFERRED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SS52~SS520	F1	Approximate 0.251	3000	6000	42000	13" reel

■ Characteristics (Typical)

FIG.1: Io-Ta Curve

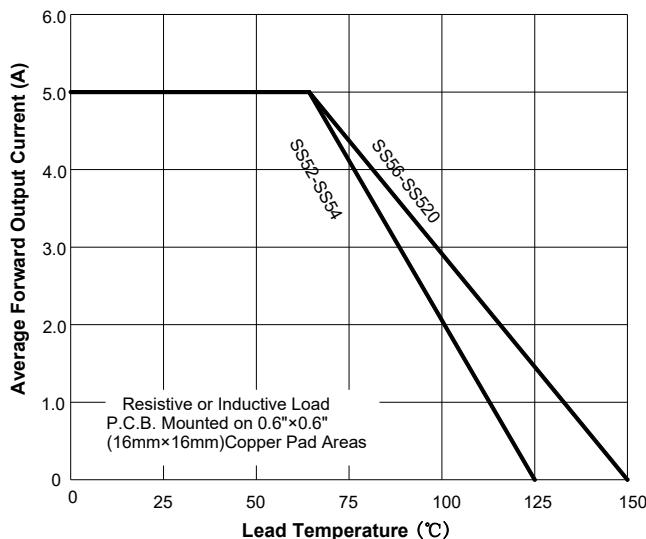


FIG.2: Forward Surge Current Capability

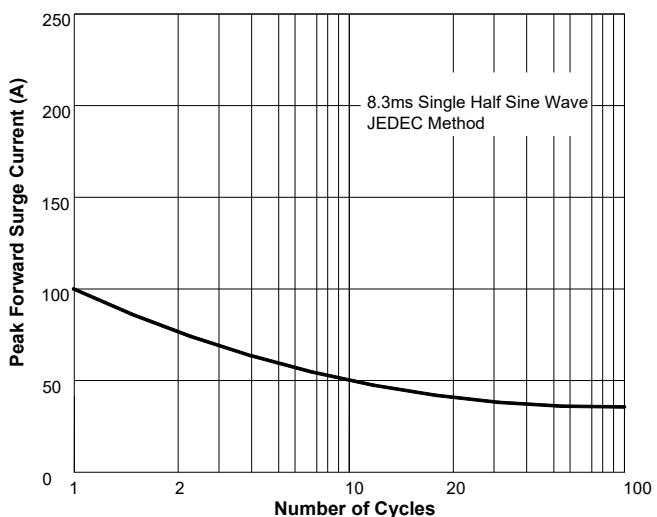


FIG.3: Forward Voltage

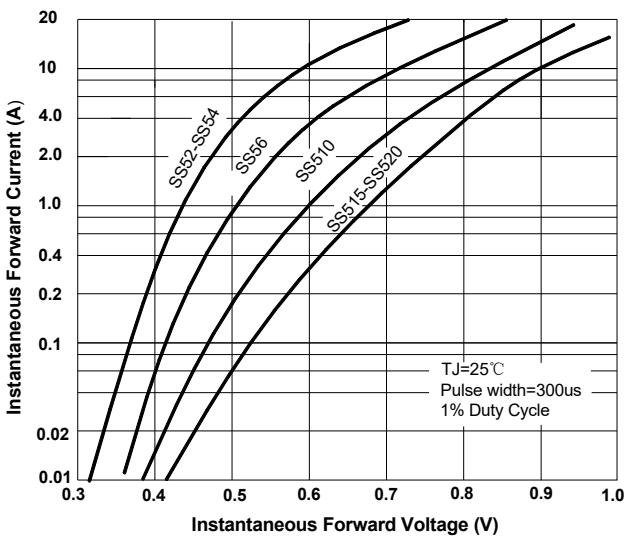
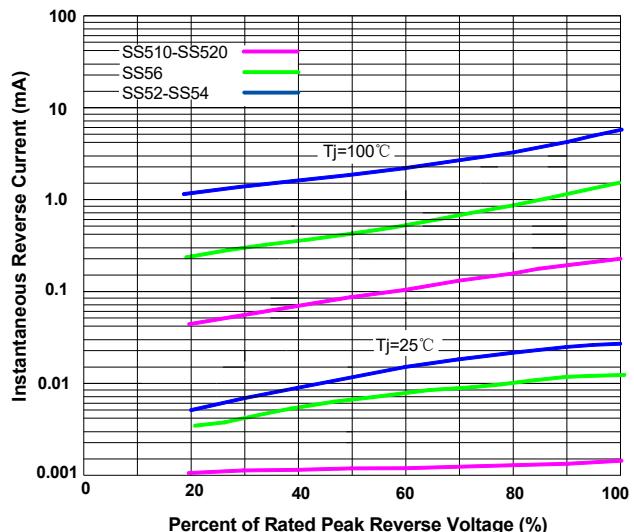
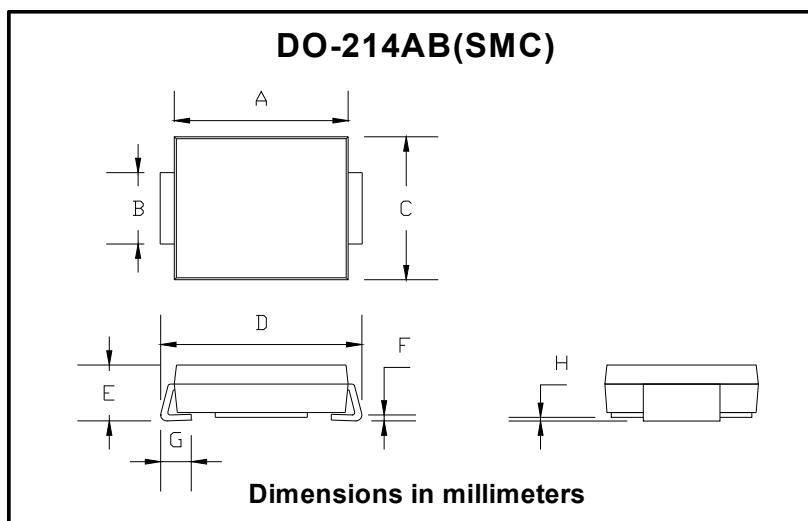


FIG.4: Typical Reverse Characteristics



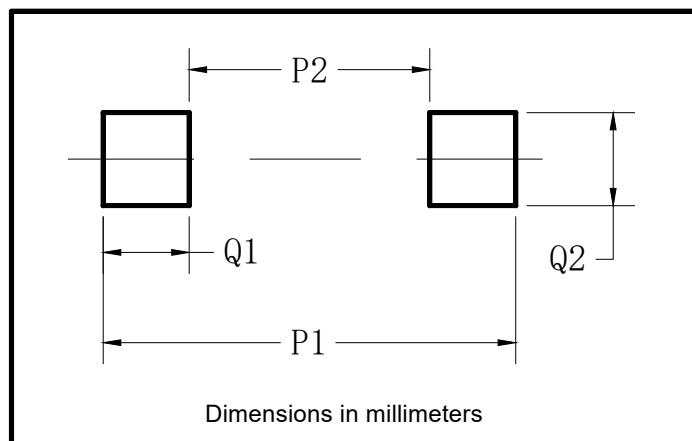
SS52 THRU SS520

■ Outline Dimensions



DO-214AB (SMC)		
Dim	Min	Max
A	6.60	7.11
B	2.85	3.27
C	5.59	6.22
D	7.75	8.13
E	1.99	2.61
F	0.15	0.31
G	0.76	1.52
H	0.05	0.20

■ Suggested pad layout



Dim	Typ
P1	9.9
P2	3.84
Q1	3.03
Q2	3.82